SLLS062C - MAY 1990 - REVISED MAY 1995

Meets or Exceeds the Requirements of D € IBM™ 360/370 Input/Output Interface D €	(TOP V	CKAGE IEW)
Specification for 4.5 Mb/s Operation		
Single 5-V Supply DE1	1	16 VCC
Uncommitted Emmitter-Follower Output	2	15 DO1
Structure for Party-Line Operation	3	14 🛛 DI1
RIZ RIZ	4	13 🛛 DO2
Driver Output Short-Circuit Protection RO2	5	12 DI2
	6	11 🛛 DO3
With TTL RO3	7	10 🛛 DI3
Receiver Input Resistance 7.4 kΩGNDto 20 kΩ	8	9] DE2

• Ratio Specification for Propagation Delay Time, Low-to-High/High-to-Low

description

The SN751730 triple line driver/receiver is specifically designed to meet the input/output interface specifications for IBM System 360/370. It is also compatible with standard TTL logic and supply voltage levels.

The low-impedance emitter-follower driver outputs of the SN751730 drive terminated lines such as coaxial cable or twisted pair. Having the outputs uncommitted allows wired-OR logic to be performed in party-line applications. Output short-circuit protection is provided by an internal clamping network that turns on when the output voltage drops below approximately 2.5 V.

An open line affects the receiver input as does a low-level input voltage.

All the driver inputs and receiver outputs are in conventional TTL configuration and the gating can be used during power-up and power-down sequences to ensure that no noise is introduced to the line by pulling either DE1 or DE2 to a low level.

	EACH		
	OUTPUT		
DI	DE1	DE2	DO
L	Х	Х	L
Х	L	Х	L
Х	Х	L	L
н	н	Н	н

Function Tables

EACH DRIVER

н
L
Н



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

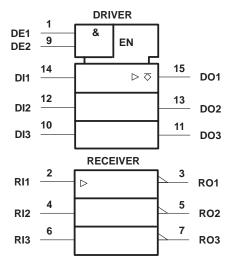
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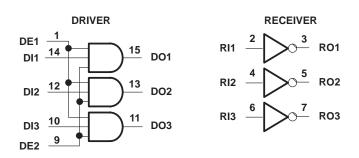


SLLS062C - MAY 1990 - REVISED MAY 1995

logic symbols[†]



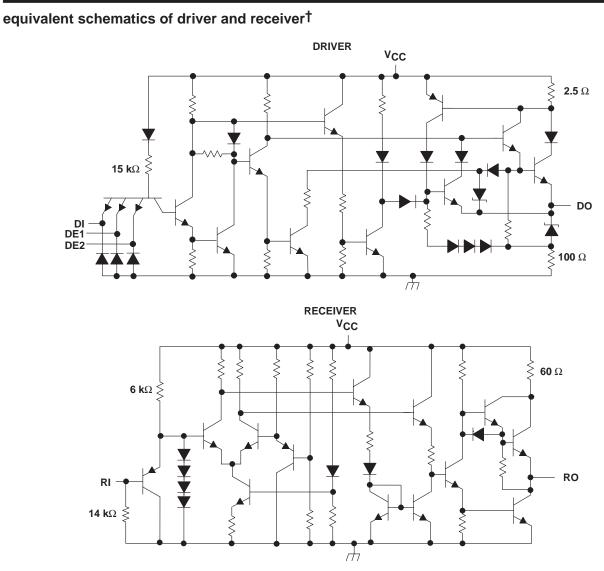
logic diagrams (positive logic)



[†] These symbols are in accordance with ANSI/IEE Std 91-1984 and IEC Publication 617-12.



SLLS062C - MAY 1990 - REVISED MAY 1995



[†] All resistor values are nominal.



SLLS062C - MAY 1990 - REVISED MAY 1995

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC} (see Note 1)	
Input voltage range, V _I : Driver	0.5 V to 7 V
Receiver	0.5 V to 7 V
Output voltage range, V _O : Driver	
Enable input voltage range	$\dots \dots $
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T _A	0°C to 70°C
Storage temperature range, T _{stg}	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

 Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
 NOTE 1: All voltage values are with respect to network ground terminal.

DISSIPATION RATING TABLE							
PACKAGE	T _A ≤ 25°C POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING				
D	950 mV	7.6 mW/°C	608 mW				
Ν	1150 mV	9.2 mW/°C	736 mW				

recommended operating conditions

			MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}			4.75	5	5.25	V
High-level input voltage, VIH	Driver, Enable		2			V
	Receiver		1.55			v
Low-level input voltage, VII	Driver, Enable				0.8	V
	Receiver				1.15	v
Operating free-air temperature, T _A			0		70	°C



SLLS062C - MAY 1990 - REVISED MAY 1995

DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER			TEST C	CONDITIONS	MIN	MAX	UNIT
VIK	Input clamp voltage		V _{CC} = 4.75 V,	I _{IL} = -18 mA		-1.5	V
			V _{CC} = 4.75 V, I _{OH} = -59.3 mA		3.11		
∨он		$V_{CC} = 5.25 \text{ V},$ $I_{OH} = -78.1 \text{ mA}$	V _{IH} = 2 V,		4.10	v	
	High-level output voltage		$V_{CC} = 4.75 \text{ V},$ $R_{L} = 51.4 \Omega$	V _{IH} = 2 V,	3.05	3.05	v
			$V_{CC} = 5.25$ V, R _L = 56.9 Ω	V _{IH} = 2 V,		4.20	
VODH	Differential high-level output voltage		$R_{L} = 46.3 \Omega \text{ or } 56.9$	Ω		0.50	V
			V _{CC} = 5.25 V,	$I_{OL} = -0.24 \text{ mA}$		0.15	
VOL	Low-level output voltage		V _{IL} = 0.8 V, V _{IH} = 4.5 V	R _L = 56.9 Ω		0.15	V
Чн	High-level input current	DI	V _{CC} = 5.25 V,	V _{IH} = 2.7 V		20	μA
Π		DE	VCC = 3.23 V,	VIH - 2.7 V		60	μΛ
١L	Low-level input current	DI	V _{CC} = 5.25 V,	VIH = 0.4 V		-400	μA
ΊL	Low-level input current	DE	VCC = 0.20 V,	VIH - 0:4 V		-1200	μΛ
	High-level output current		V _{CC} = 4.75 V,	$V_{IL} = 0$		100	μA
юн	riigii-ievel ouput current		V _{OH} = 5 V	VIH = 4.5 V		100	μΑ
los	Short-circuit output current [†]		V _{CC} = 5.25 V	V _{IH} = 4.5 V		-30	mA
IССН			V _{CC} = 5.25 V,	$V_{I(D)} = 4.5 V,$ $V_{I(R)} = 0$		47	
ICCL	 Supply current (total package) 		No load	$V_{I(D)} = 0,$ $V_{I(R)} = 4.5 V$		80	mA

[†] No more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V $\pm 5\%,$ T_A = 25°C

	PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
^t PLH	Propagation delay time, low- to high-level output			6.5	12	18.5	ns
^t PHL	Propagation delay time, high- to low-level output	R _L = 47.5 Ω,	See Figure 1	6.5	12	18.5	ns
Δt_{pd}	Differential propagation delay time [‡]					10	ns
tr	Output rise time	$V_{CC} = 5 V,$	$V_{O} = 0.15 \text{ V to } 3.05 \text{ V},$	5	10		ns
t _f	Output fall time	$R_L = 47.5 \Omega$, See Figure 1	C _L = 10.2 pF,	5	13		ns
SR	Slew rate	$V_O = 1 V \text{ to } 3 V \text{ at}$ R _L = 47.5 Ω , See Figure 1				0.65	V/ns

 $\pm \Delta t_{pd} = |t_{PLH} - t_{PHL}|$



SLLS062C - MAY 1990 - REVISED MAY 1995

RECEIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST CONDITIONS		MIN	MAX	UNIT
VOH	High-level output voltage	V _{CC} = 4.75 V, I _{OH} = -400 μA	V _I = 1.15 V,	2.7		V
Vai		V _{CC} = 4.75 V,	I _{OL} = 8 mA		0.5	V
VOL	Low-level output voltage	V _{IH} = 1.55 V	I _{OL} = 4 mA		0.4	v
rı	Input resistance	$V_{CC} = 0,$	$V_I = 0.15 \text{ V}$ to 3.9 V	7.4	20	kΩ
Чн	High-level input current	V _{CC} = 4.75 V,	V _{IH} = 3.11 V		0.42	mA
Ι _{ΙL}	Low-level input current	V _{CC} = 5.25 V,	V _{IL} = 0.15 V	-0.24	0.04	mA
los†	Short-circuit output current	V _{CC} = 5.25 V,	$V_{IL} = 0$	-20	-100	mA
Іссн		V _{CC} = 5.25 V,	$V_{I(D)} = 4.5 V,$ $V_{I(R)} = 0$		47	mA
ICCL	Supply current (total package) No load	VI(D) = 0, VI(R) = 4.5 V		80	ША	

[†] Only one output should be shorted at a time, and duration of the short circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V $\pm 5\%,$ T_A = 25°C

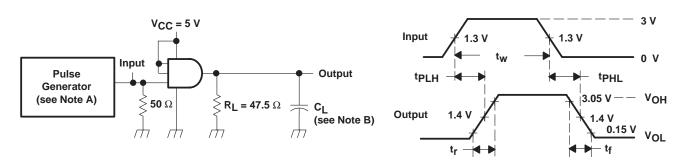
PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
t _{PLH} F	Propagation delay time, low- to high-level output				7.5	12	19.5	ns
t _{PHL} F	Propagation delay time, high- to low-level output	$R_L = 2 k\Omega$,	C _L = 15 pF,	See Figure 2	7.5	12	19.5	ns
∆t _{pd} ‡ □	Differential propagation delay time						10	ns

 $\pm \Delta t_{pd} = |t_{PLH} - t_{PHL}|$



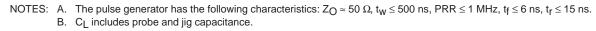
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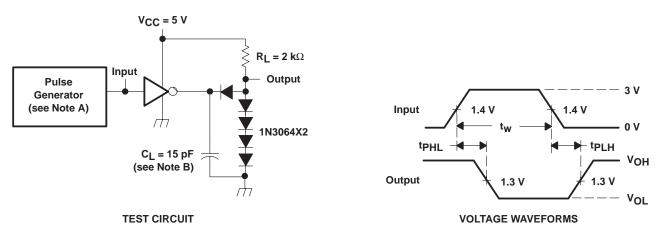


TEST CIRCUIT

VOLTAGE WAVEFORMS







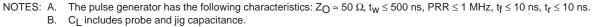


Figure 2. Receiver Test Circuit and Voltge Waveforms



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